

DATA SHEET

CURRENT SENSOR - LOW TCR

PE Series - Wide Terminal 5%, 1%, 0.5%

RoHS compliant & Halogen free



YAGEO Phícomp



SCOPE

This specification describes PE series wide-terminal current sensor - low TCR chip resistors made by metal alloy process.

APPLICATIONS

- Battery pack
- Inverter/converter (DC-DC/AC-DC/DC-AC)
- Consumer electronics
- Laptops
- Automotive
- Alternative Energy

FEATURES

- AEC-Q200 qualified
- This product with lead-free terminations meet RoHS requirements
- High component and equipment reliability
- Ultra low resistance and narrow tolerance suitable for current detection

ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

PE XXXX X X X XX XXXX L (7)

(2) (3) (4) (5)

(I) SIZE

0508/0612/0815

(2) TOLERANCE

 $D = \pm 0.5\%$ (by request) $F = \pm 1\%$ $J = \pm 5\%$

(3) PACKAGING TYPE

R = Paper taping reel K= Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

 $E = \pm 50 \text{ ppm/°C}$

 $M = \pm 75 \text{ ppm/}^{\circ}\text{C}$

 $F = \pm 100 \text{ ppm/}^{\circ}\text{C}$

 $L = \pm 150 \text{ ppm/°C}$

(5) TAPING REEL

07/7W = 7 inch dia. Reel and specific rated power. Detailed power ratings are shown in the Table 2

(6) RESISTANCE VALUE

OROOI (I m Ω) ~ IR (I Ω)

There are 3~5 digits indicated the resistance value. Letter R is decimal point.

(7) DEFAULT CODE

L = system default code for ordering only

ORDERING EXAMPLE

The ordering code of a PE0508 IW chip resistor, value 0.01 Ω with ±1% tolerance TCR ±75 ppm/°C, supplied in 7-inch tape reel with 5Kpcs quantity is: PE0508FRM070R01L.

NOTE

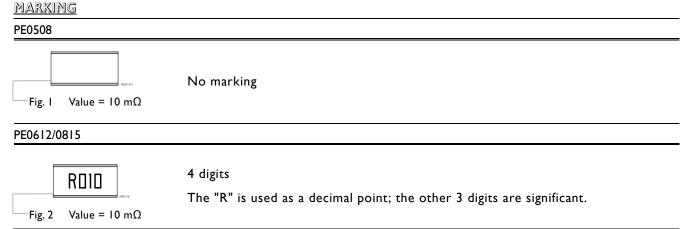
I. All our RSMD products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead-Free Process"



Chip Resistor Surface Mount

3 12





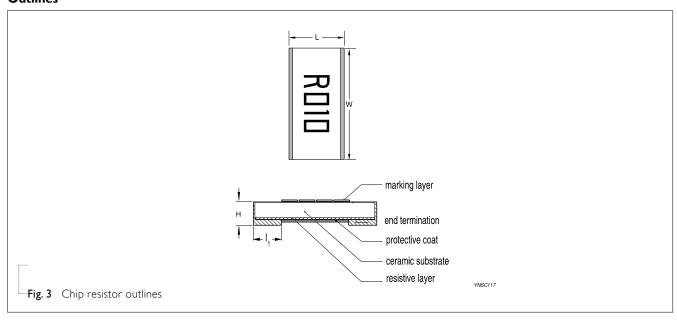
CONSTRUCTION

The resistors are constructed using outstanding TCR level material, which makes Yageo PE resistors excellent for current sensing application.

The composition of the resistive material is adjusted to give the approximate required resistance and is covered with a protective coating. Marking is printed on the top side of the resistor.

Finally, the three external terminations (Cu / Ni / matte Tin) are added, as shown in Fig. 3.

Outlines



DIMENSION

Table I

TYPE	RESISTANCE RANGE	L (mm)	W (mm)	H (mm)	I _I (mm)
PE0508	$5 \text{ m}\Omega \leq R \leq I\Omega$	1.25±0.10	2.00±0.10	0.55±0.15	0.35±0.15
	l mΩ	1.60±0.20	3.20±0.20	0.60±0.15	0.55±0.20
PE0612	$2 \text{ m}\Omega \leq R \leq 4 \text{ m}\Omega$	1.60±0.20	3.20±0.20	0.60±0.15	0.40±0.15
	$5 \text{ m}\Omega \leq R \leq I\Omega$	1.60±0.20	3.20±0.20	0.60±0.15	0.30±0.15
DECOLE	$I\ m\Omega \leq R \leq 2\ m\Omega$	2.00±0.20	3.70±0.20	0.60±0.15	0.50±0.20
PE0815	$3 \text{ m}\Omega \leq R \leq 20 \text{ m}\Omega$	2.00±0.20	3.70±0.20	0.60±0.15	0.60±0.20

Note:

- 1. For relevant physical dimensions, please refer to construction outlines.
- 2. Please contact with sales offices, distributors and representatives in your region before ordering.

ELECTRICAL CHARACTERISTICS

Table 2

POWER RATING		ATING (I)	TOLEDANICE	RESISTANCE RANGE	TEMPERATURE COEFFICIENT	
1 TPE	TYPE TOLERANCE 07 7W		RESISTAINCE RAINGE	OF RESISTANCE		
PE0508	1			$5 \text{ m}\Omega \le R < 75 \text{ m}\Omega$ $75 \text{ m}\Omega \le R \le I\Omega$	±100ppm/°C ±50ppm/°C	
PE0612	I		± 0.5% (By request) ±1% ±5%	$\begin{array}{c} \text{I m}\Omega \\ \text{2 m}\Omega \\ \text{3 m}\Omega \leq \text{R} \leq \text{I}\Omega \end{array}$	±150ppm/°C ±100ppm/°C ±50ppm/°C, ±75ppm/°C, ±100ppm/°C	
PE0815	1/2W	IW		$Im\Omega \le R \le 20 m\Omega$	±75ppm/°C ±100ppm/°C	

Note: I. Global part number (code 10 - 11)

2. Please contact with sales offices, distributors and representatives in your region before ordering.



FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

Range: -55°C to +155°C

POWER RATING

Standard rated power at 70°C:

PE0508 = IW

PE0612 = IW

PE0815 = I/2W; IW

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

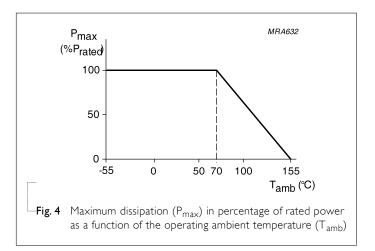
$$V = \sqrt{(P*R)}$$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$



PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	PE0508	PE0612	PE0815
Paper taping reel (R)	7" (178 mm)	5,000		
Embossed taping reel (K)	7" (178 mm)		5000	4000

PAPER TAPE

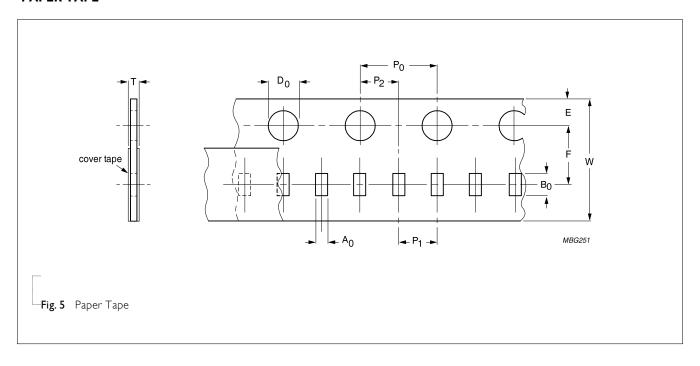


Table 4 Dimensions of paper tape for relevant chip resistors size

SIZE	SYMBOL									Unit: mm
	A ₀	B ₀	W	Е	F	P ₀	Pı	P ₂	ØD ₀	Т
PE0508	1.50± 0.15	2.25± 0.15	8.00±0.30	1.75±0.10	3.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	0.75± 0.15

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EMBOSSED TAPE

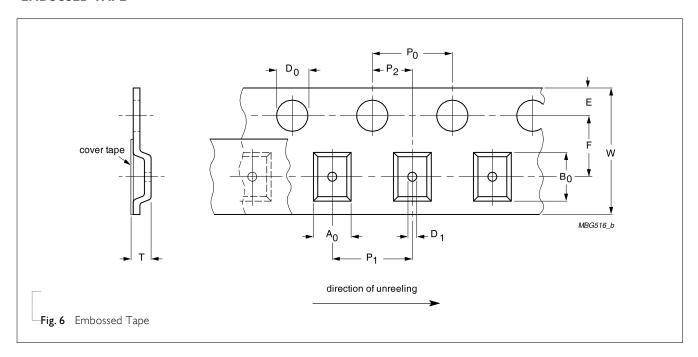


Table 5 Dimensions of embossed tape for relevant chip resistors size

SIZE	SYMBOL										Unit: mm
	A ₀	B ₀	W	E	F	P ₀	Pı	P ₂	ØD ₀	Dı	Т
PE0612	1.80±0.15	3.52± 0.15	8.00±0.30	1.75±0.10	3.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	1.50±0.10	0.75± 0.15
PE0815	2.25±0.15	4.00± 0.15	12.00±0.30	1.75±0.10	5.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	1.50±0.10	0.75± 0.15

REEL SPECIFICATION

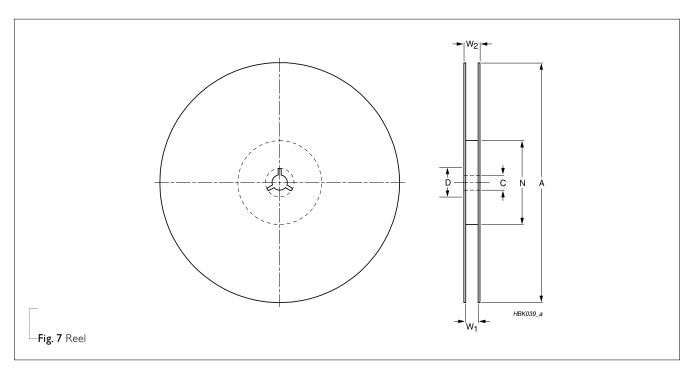


Table 6 Dimensions of reel specification for relevant chip resistors size

SIZE	SYMBOL						Unit: mm
	8 mm TAPE WIDE	Α	N	С	D	Wı	W _{2 MAX.}
PE0508	7" (Ø178 mm)	178.0±5	60.0+1/-0	13.00±0.5	17.70±0.5	8.4 +1/-0	12.4±1
PE0612	7" (Ø178 mm)	178.0±5	60.0+1/-0	13.00±0.5	17.70±0.5	8.4 +1/-0	2.4±

SIZE	SYMBOL						Unit: mm
	I2 mm	Α	N	С	D	Wı	W _{2 MAX.}
	TAPE WIDE						
PE0815	7" (Ø178 mm)	178.0 ±5	60.0 + 1/-0	13.00±0.5	17.70±0.5	12.3 +1/-0	18.4±1

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SOLDERING PROFILES

For recommended soldering profiles, please refer to data sheet "Chip resistors mounting".

<u>FOOTPRINT</u>

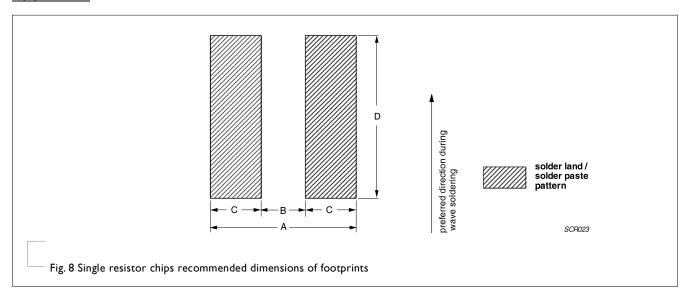


Table 7 Footprint dimensions

SIZE	RESISTANCE RANGE				Unit: mm
3126	RESISTANCE RAINGE	Α	В	С	D
PE0508	$5 \mathrm{m}\Omega \le R \le \mathrm{I}\Omega$	1.80~2.00	0.40~0.60	0.70	2.00
DECCLO	$I\ m\Omega \leq R \leq 4m\Omega$	4.60	0.40	2.10	3.68
PE0612	$5 \text{ m}\Omega \leq R \leq I\Omega$	4.60	0.60	2.00	3.68
PE0815	$Im\Omega \le R \le 20m\Omega$	3.38	0.58	1.40	4.20



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TESTS AND REQUIREMENTS

Table 8 Test condition, procedure and requirements

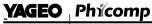
TEST METHOD	PROCEDURE	REQUIREMENTS
IEC 60115-1 4.25.1	I,000 hours at 70±5 °C applied RCWV I.5 hours on, 0.5 hour off, still air required	±(1%+0.0005 Ω)
IEC 60068-2-2	I,000 hours at maximum operating temperature depending on specification, unpowered No direct impingement of forced air to the parts Tolerances: I55±5 °C	±(1%+0.0005 Ω)
MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	±(0.5%+0.0005 Ω)
	Parts mounted on test-boards, without condensation on parts	
	Measurement at 24±2 hours after test conclusion	
IEC60115-1 4.13	5 times of rated power for 5 seconds at room temperature	$\pm (0.5\% + 0.0005~\Omega)$ No visible damage
IEC60068-2-21	Device mounted on 90mm glass epoxy resin PCB test board (FR4), 2 mm bending Bending time: 60±5 seconds	±(1%+0.0005 Ω) No visible damage
	IEC 60115-1 4.25.1 IEC 60068-2-2 MIL-STD-202 Method 106	IEC 60115-1 4.25.1 I,000 hours at 70±5 °C applied RCWV 1.5 hours on, 0.5 hour off, still air required IEC 60068-2-2 I,000 hours at maximum operating temperature depending on specification, unpowered No direct impingement of forced air to the parts Tolerances: 155±5 °C MIL-STD-202 Method 106 Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered Parts mounted on test-boards, without condensation on parts Measurement at 24±2 hours after test conclusion IEC60115-1 4.13 5 times of rated power for 5 seconds at room temperature IEC60068-2-21 Device mounted on 90mm glass epoxy resin PCB test board (FR4), 2 mm bending

PE

SERIES

0508/0612/0815

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS	
Solderability				
- Wetting	J-STD-002B test B	Electrical Test not required	Well tinned (≥95% covered)	
		Magnification 50X	No visible damage	
		SMD conditions:		
		I st step: method B, aging 4 hours at 155 °C dry heat		
		2^{nd} step: leadfree solder bath at 245 $\pm 3~^{\circ}\mathrm{C}$		
		Dipping time: 3±0.5 seconds		
- Resistance to	IEC 60068-2-58	Condition B, no pre-heat of samples	±(0.5%+0.0005 Ω)	
Soldering Heat		Leadfree solder, 260 °C, 10±1 seconds No visible damage immersion time		
		Procedure 2 for SMD: devices fluxed and cleaned with isopropanol		



Product specification 12

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Chip Resistor Surface Mount PE SERIES 0508/0612/0815

REVISION HISTORY

REVISION DATE CHANGE NO	TIFICATION DESCRIPTION
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Version 0 Dec. 03, 2018 -

- New datasheet for current sensor - low TCR wide terminal PE series with lead-free terminations.

[&]quot;Yageo reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."

